

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	ZHONGJIANG QU	12/01/2018
	YAOYIN FAN	12/01/2018
RECEIVING PARTY DATA		
Name:	CELESTICA TECHNOLOGY CONSULTANCY (SHANGHAI) CO. LTD	
Street Address:	RM 701, 801, A TOWER, A BUILD, 3000 LONGDONG AVE	
Internal Address:	ZHANGJIANG HI-TECH PARK, PUDONG DISTRICT	
City:	SHANGHAI	
State/Country:	CHINA	
Postal Code:	201203	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	16234886	
CORRESPONDENCE DATA		
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NAME OF SUBMITTER:	TIANHUA GU	
SIGNATURE:	/TIANHUA GU/	
DATE SIGNED:	03/17/2019	
Total Attachments: 1		
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ASSIGNMENT GUH-404

WHEREAS, I/WE:

QU, Zhongjiang; FAN, Yaoyin, residing in
Room 701,801,A Tower, A Building,No 3000 LongDong Avenue, Zhangjiang Hi-tech
park, Pudong district,Shanghai-201203,China

have invented certain new and useful improvements in the following:

CLOSED LOOP LIQUID COOLER AND ELECTRONIC DEVICE USING THE SAME

for which a United States patent application therefor has been executed on 12/1/2018 U.S. Patent
Application No.: 16/234886;

WHEREAS,

Celestica Technology Consultancy (Shanghai) Co. Ltd.

(hereinafter referred to as the Assignee), residing at Room 701,801,A Tower, A Building,No 3000
LongDong Avenue, Zhangjiang Hi-tech park, Pudong district,Shanghai-201203,China desires to
acquire the entire right, title and interest in said application and invention, and to any United States and
foreign patents to be obtained therefor.

NOW THEREFORE, for a valuable consideration, receipt whereof is hereby acknowledged, I/we, the
above named, hereby sell, assign, and transfer to Assignee, its successors and assigns, the entire right,
title and interest in said application and inventions therein disclosed for the United States and foreign
countries, and all rights of priority resulting from the filing of said application, I/we hereby agree that
Assignee may apply for foreign Letters Patent on said inventions, and I/we hereby agree to timely
execute all papers necessary in connection with said United States and foreign Letters Patent
applications when called upon to do so by Assignee.

I/we hereby covenant that I/we have the full and lawful right to convey the entire right, title, and
interest herein assigned, and that I/we have not entered and will not enter into any agreement in
conflict herewith.

I/we hereby request the Commissioner for Patents to issue any Letters Patent granted upon the
inventions set forth in said application to Assignee, its successors and assigns.

ASSIGNOR SIGNATURE(S)

Qu, Zhongjiang
QU, Zhongjiang

Dec. 1, 2018
Date

FAN, Yaoyin
FAN, Yaoyin

Dec. 1, 2018
Date